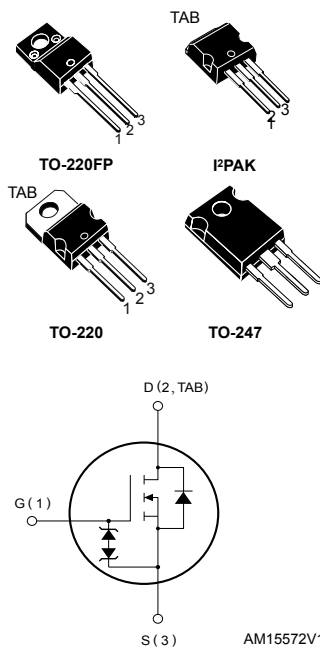


## N-channel 600 V, 0.108 $\Omega$ typ., 26 A, MDmesh M2 Power MOSFETs in TO-220FP, I<sup>2</sup>PAK, TO-220 and TO-247 packages



### Features

Order codes	$V_{DS} @ T_{Jmax}$	$R_{DS(on)}$ max.	$I_D$	Package
STF33N60M2	650 V	0.125 $\Omega$	26 A	TO-220FP
STI33N60M2				I <sup>2</sup> PAK
STP33N60M2				TO-220
STW33N60M2				TO-247

- Extremely low gate charge
- Excellent output capacitance ( $C_{OSS}$ ) profile
- 100% avalanche tested
- Zener-protected

### Applications

- Switching applications
- LLC converters, resonant converters

### Description

These devices are N-channel Power MOSFETs developed using the MDmesh M2 technology. Thanks to their strip layout and improved vertical structure, these devices exhibit low on-resistance and optimized switching characteristics, rendering them suitable for the most demanding high-efficiency converters.



#### Product status links

[STF33N60M2](#)

[STI33N60M2](#)

[STP33N60M2](#)

[STW33N60M2](#)

# 1 Electrical ratings

**Table 1. Absolute maximum ratings**

Symbol	Parameter	Value		Unit
		TO-220FP	I <sup>2</sup> PAK, TO-220, TO-247	
V <sub>GS</sub>	Gate-source voltage	±25		V
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 25 °C	26 <sup>(1)</sup>	26	A
	Drain current (continuous) at T <sub>C</sub> = 100 °C	16 <sup>(1)</sup>	16	A
I <sub>DM</sub> <sup>(2)</sup>	Drain current (pulsed)	104 <sup>(1)</sup>	104	A
P <sub>TOT</sub>	Total power dissipation at T <sub>C</sub> = 25 °C	35	190	W
dv/dt <sup>(3)</sup>	Peak diode recovery voltage slope	15		V/ns
dv/dt <sup>(4)</sup>	MOSFET dv/dt ruggedness	50		V/ns
V <sub>ISO</sub>	Insulation withstand voltage (RMS) from all three leads to external heat sink (t = 1 s, T <sub>C</sub> = 25 °C)	2500		V
T <sub>stg</sub>	Storage temperature range	-50 to 150		°C
T <sub>j</sub>	Operating junction temperature range			

- Limited by maximum junction temperature.
- Pulse width is limited by safe operating area.
- I<sub>SD</sub> ≤ 26 A, di/dt ≤ 400 A/μs, V<sub>DS peak</sub> < V<sub>(BR)DSS</sub>, V<sub>DD</sub> = 400 V
- V<sub>DS</sub> ≤ 480 V

**Table 2. Thermal data**

Symbol	Parameter	Value			Unit
		TO-220FP	I <sup>2</sup> PAK TO-220	TO-247	
R <sub>thj-case</sub>	Thermal resistance junction-case	3.6	0.66		°C/W
R <sub>thj-amb</sub>	Thermal resistance junction-ambient	62.5		50	°C/W

**Table 3. Avalanche characteristics**

Symbol	Parameter	Value	Unit
I <sub>AR</sub>	Avalanche current, repetitive or not repetitive (pulse width limited by T <sub>jmax</sub> )	5	A
E <sub>AS</sub>	Single pulse avalanche energy (starting T <sub>j</sub> = 25 °C, I <sub>D</sub> = I <sub>AR</sub> , V <sub>DD</sub> = 50 V)	450	mJ

## 2 Electrical characteristics

( $T_C = 25\text{ °C}$  unless otherwise specified).

**Table 4. On/off states**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$I_D = 1\text{ mA}$ , $V_{GS} = 0\text{ V}$	600			V
$I_{DSS}$	Zero gate voltage drain current	$V_{GS} = 0\text{ V}$ , $V_{DS} = 600\text{ V}$			1	$\mu\text{A}$
		$V_{GS} = 0\text{ V}$ , $V_{DS} = 600\text{ V}$ , $T_C = 125\text{ °C}^{(1)}$			100	$\mu\text{A}$
$I_{GSS}$	Gate-body leakage current	$V_{DS} = 0\text{ V}$ , $V_{GS} = \pm 25\text{ V}$			$\pm 10$	$\mu\text{A}$
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}$ , $I_D = 250\text{ }\mu\text{A}$	2	3	4	V
$R_{DS(on)}$	Static drain-source on-resistance	$V_{GS} = 10\text{ V}$ , $I_D = 13\text{ A}$		0.108	0.125	$\Omega$

1. Defined by design, not subject to production test.

**Table 5. Dynamic**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$C_{iss}$	Input capacitance	$V_{DS} = 100\text{ V}$ , $f = 1\text{ MHz}$ , $V_{GS} = 0\text{ V}$	-	1781	-	pF
$C_{oss}$	Output capacitance		-	85	-	pF
$C_{rss}$	Reverse transfer capacitance		-	2.5	-	pF
$C_{oss\text{ eq.}}^{(1)}$	Equivalent output capacitance	$V_{DS} = 0$ to $480\text{ V}$ , $V_{GS} = 0\text{ V}$	-	135	-	pF
$R_G$	Intrinsic gate resistance	$f = 1\text{ MHz}$ , $I_D = 0\text{ V}$	-	5.2	-	$\Omega$
$Q_g$	Total gate charge	$V_{DD} = 480\text{ V}$ , $I_D = 26\text{ A}$ , $V_{GS} = 0$ to $10\text{ V}$ (see Figure 19. Test circuit for gate charge behavior)	-	45.5	-	nC
$Q_{gs}$	Gate-source charge		-	9.9	-	nC
$Q_{gd}$	Gate-drain charge		-	18.5	-	nC

1.  $C_{oss\text{ eq.}}$  is defined as a constant equivalent capacitance giving the same charging time as  $C_{oss}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ .

**Table 6. Switching times**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on delay time	$V_{DD} = 300\text{ V}$ , $I_D = 13\text{ A}$ , $R_G = 4.7\text{ }\Omega$ , $V_{GS} = 10\text{ V}$	-	16	-	ns
$t_r$	Rise time		-	9.6	-	ns
$t_{d(off)}$	Turn-off delay time	(see Figure 18. Test circuit for resistive load switching times and Figure 23. Switching time waveform)	-	109	-	ns
$t_f$	Fall time		-	9	-	ns

**Table 7. Source drain diode**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$I_{SD}$	Source-drain current		-		26	A
$I_{SDM}^{(1)}$	Source-drain current (pulsed)		-		104	A
$V_{SD}^{(2)}$	Forward on voltage	$I_{SD} = 26 \text{ A}$ , $V_{GS} = 0 \text{ V}$	-		1.6	V
$t_{rr}$	Reverse recovery time	$I_{SD} = 26 \text{ A}$ , $di/dt = 100 \text{ A}/\mu\text{s}$	-	375		ns
$Q_{rr}$	Reverse recovery charge	$V_{DD} = 60 \text{ V}$	-	5.6		$\mu\text{C}$
$I_{RRM}$	Reverse recovery current	(see Figure 20. Test circuit for inductive load switching and diode recovery times)	-	30		A
$t_{rr}$	Reverse recovery time	$I_{SD} = 26 \text{ A}$ , $di/dt = 100 \text{ A}/\mu\text{s}$	-	478		ns
$Q_{rr}$	Reverse recovery charge	$V_{DD} = 60 \text{ V}$ , $T_j = 150 \text{ }^\circ\text{C}$	-	7.7		$\mu\text{C}$
$I_{RRM}$	Reverse recovery current	(see Figure 20. Test circuit for inductive load switching and diode recovery times)	-	35.5		A

1. Pulse width limited by safe operating area.
2. Pulsed: pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5%.

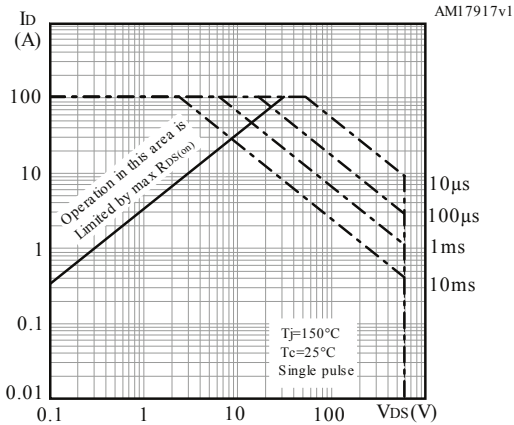
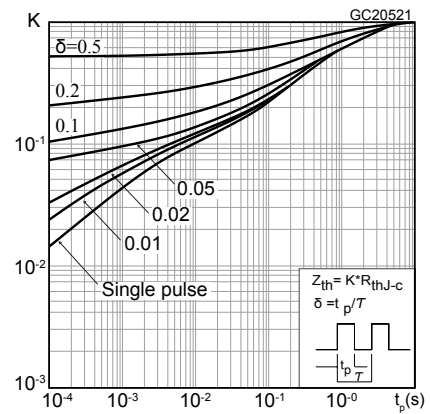
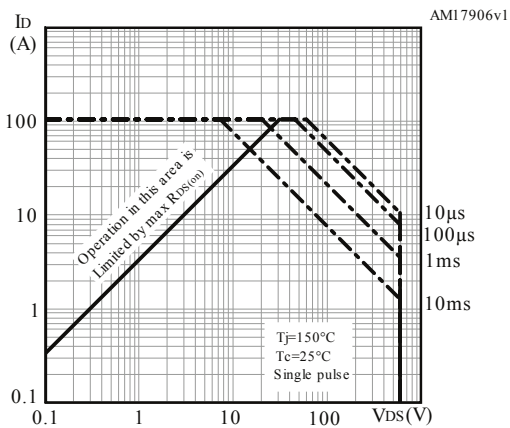
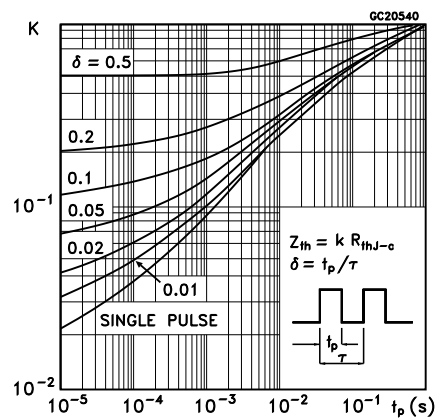
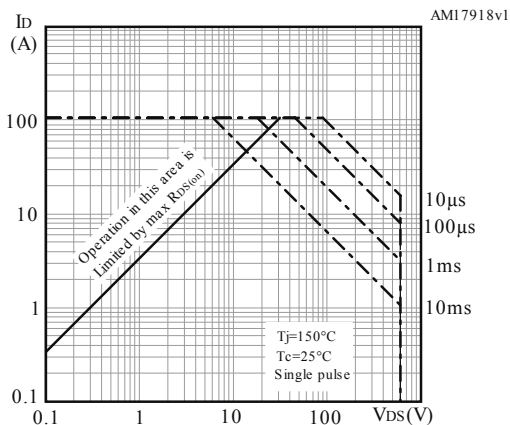
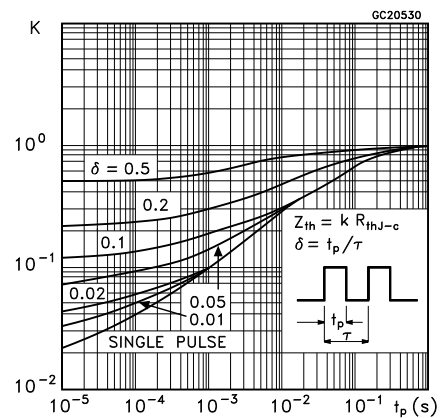
**2.1 Electrical characteristics (curves)**
**Figure 1. Safe operating area for TO-220FP**

**Figure 2. Thermal impedance for TO-220FP**

**Figure 3. Safe operating area for I<sup>2</sup>PAK and TO-220**

**Figure 4. Thermal impedance for I<sup>2</sup>PAK and TO-220**

**Figure 5. Safe operating area for TO-247**

**Figure 6. Thermal impedance for TO-247**


Figure 7. Output characteristics

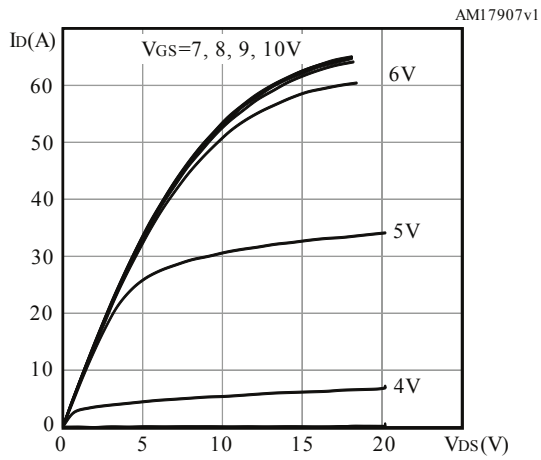


Figure 8. Transfer characteristics

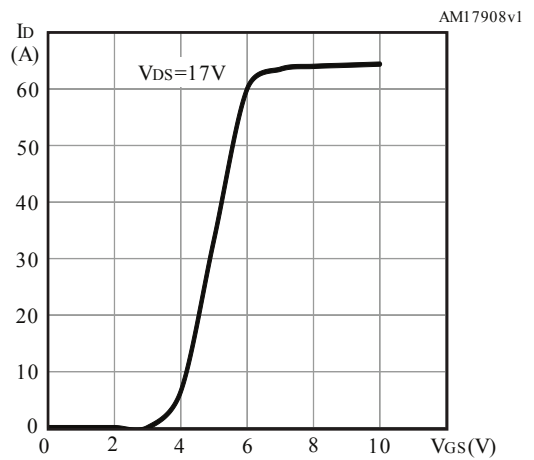


Figure 9. Gate charge vs gate-source voltage

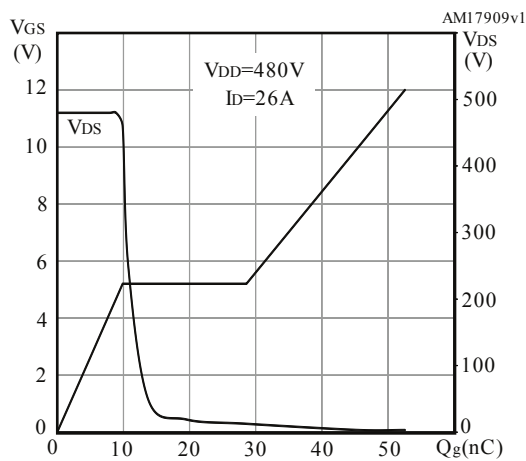


Figure 10. Static drain-source on-resistance

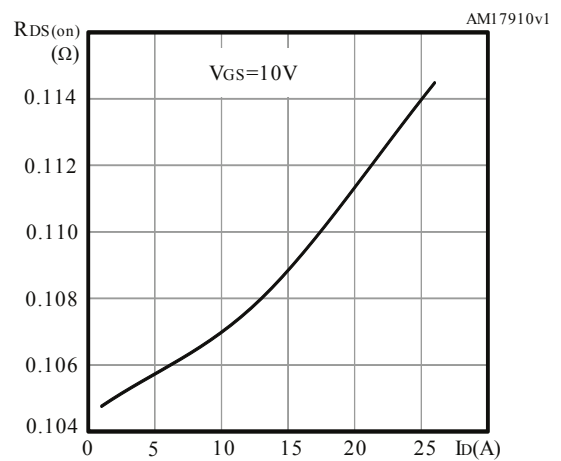


Figure 11. Capacitance variations

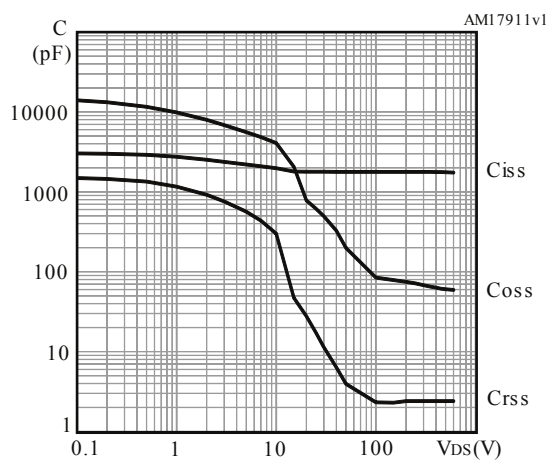
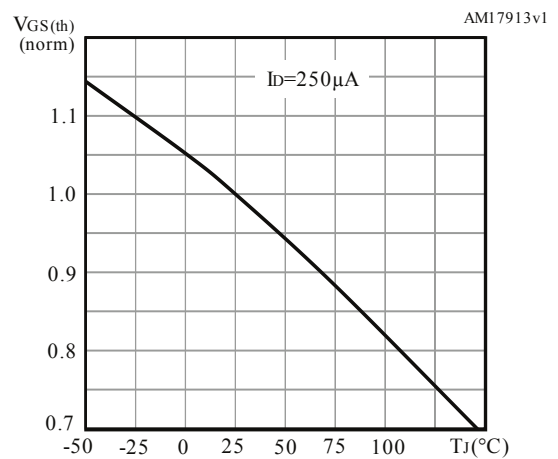
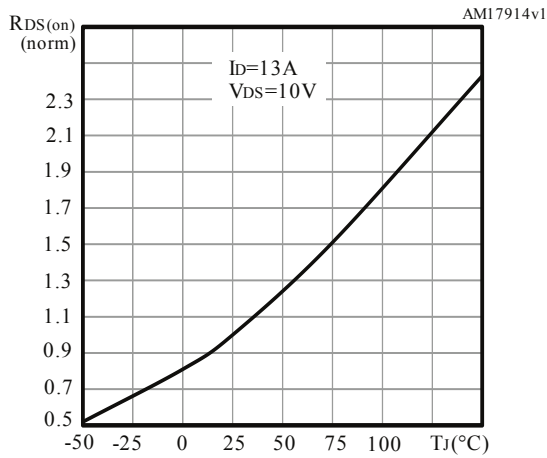
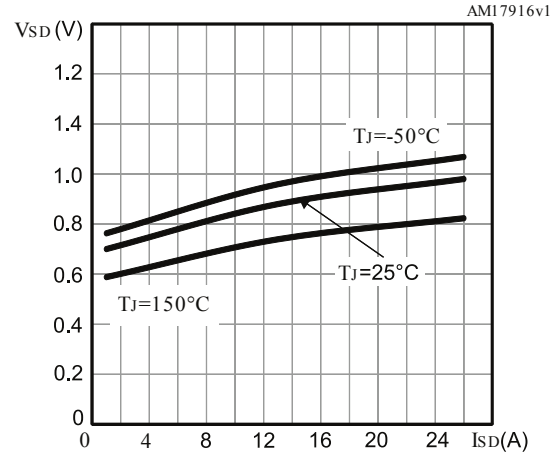
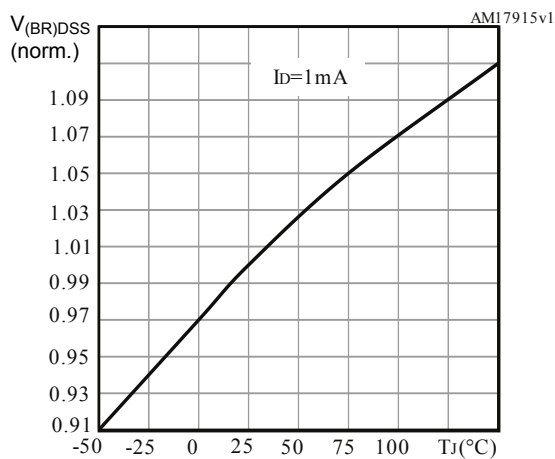
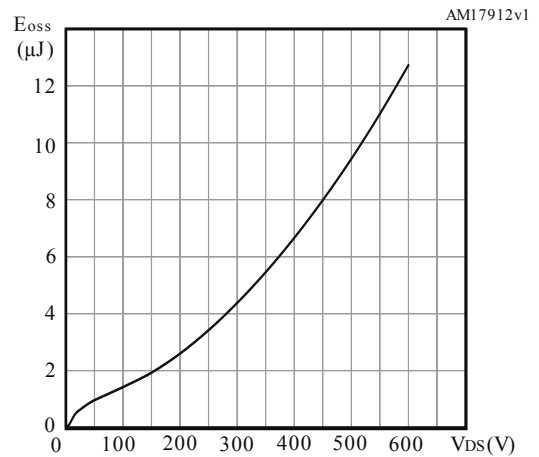
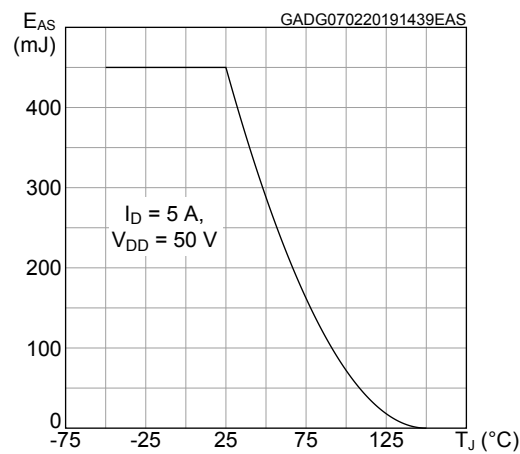


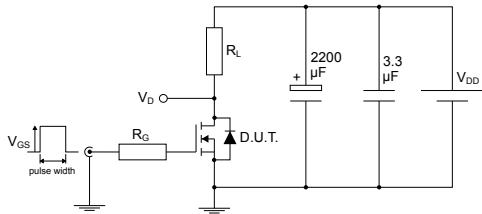
Figure 12. Normalized gate threshold voltage vs temperature



**Figure 13. Normalized on-resistance vs temperature**

**Figure 14. Source-drain diode forward characteristics**

**Figure 15. Normalized  $V_{(BR)DSS}$  vs temperature**

**Figure 16. Output capacitance stored energy**

**Figure 17. Maximum avalanche energy vs temperature**


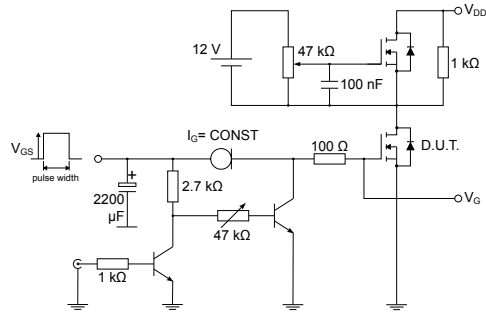
### 3 Test circuits

Figure 18. Test circuit for resistive load switching times



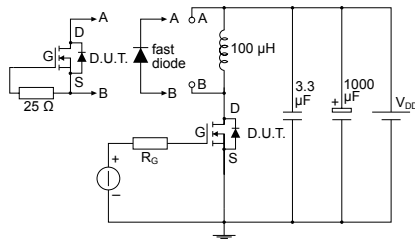
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Figure 19. Test circuit for gate charge behavior



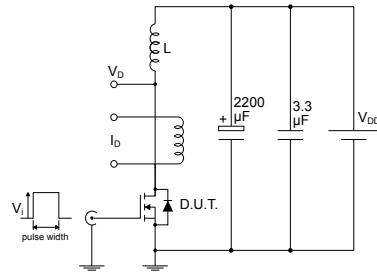
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Figure 20. Test circuit for inductive load switching and diode recovery times



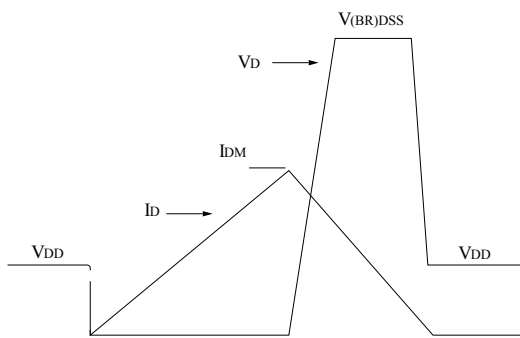
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Figure 21. Unclamped inductive load test circuit



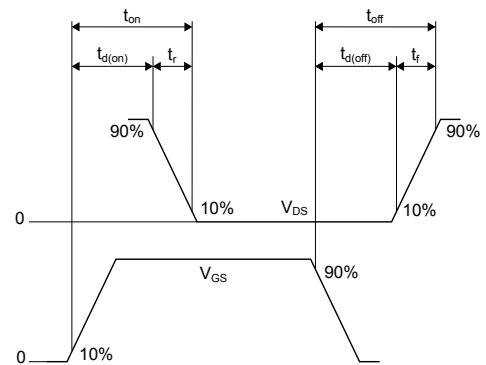
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Figure 22. Unclamped inductive waveform



AM01472v1

Figure 23. Switching time waveform



AM01473v1

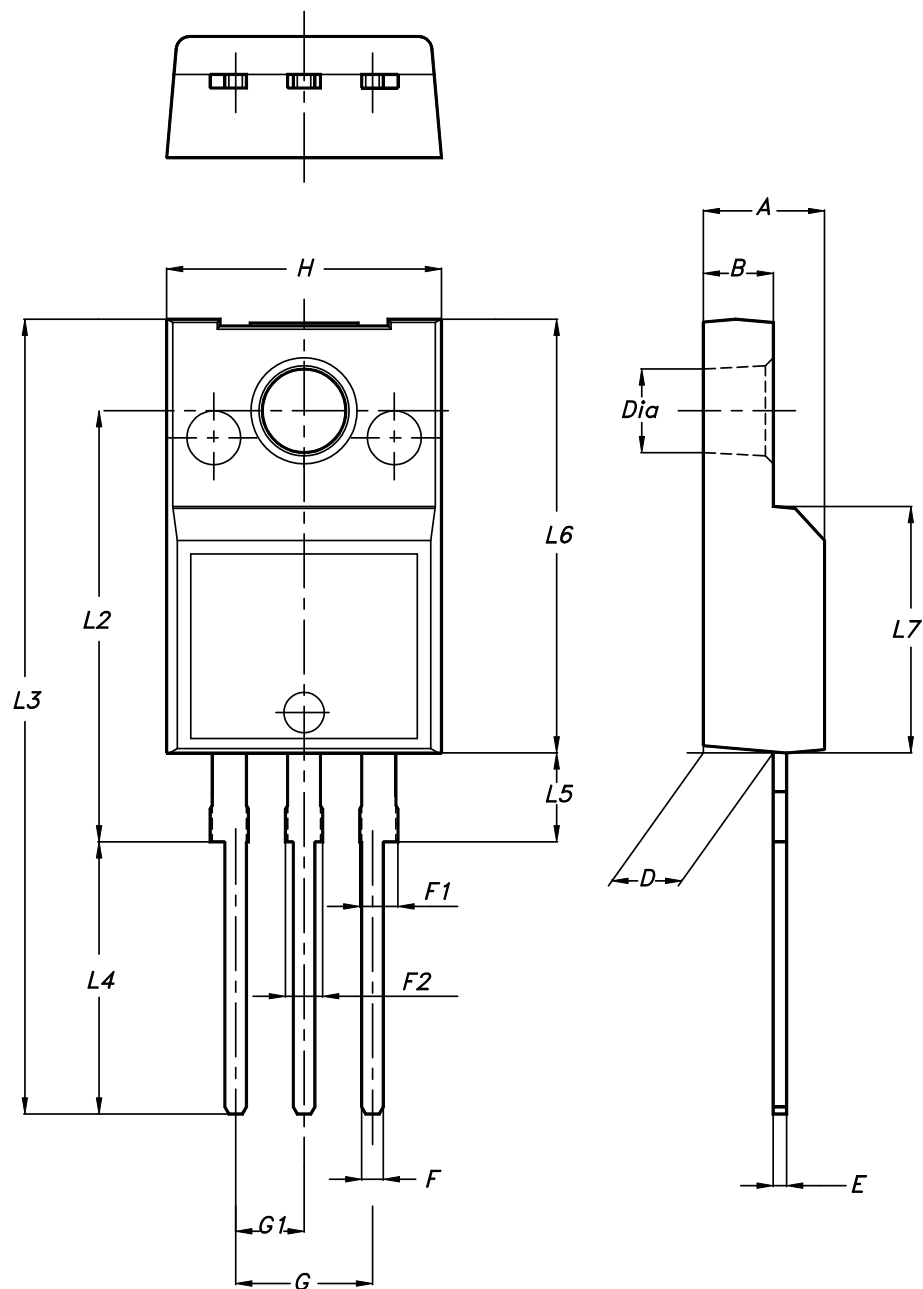


## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of **ECOPACK** packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK is an ST trademark.

### 4.1 TO-220FP package information

Figure 24. TO-220FP package outline



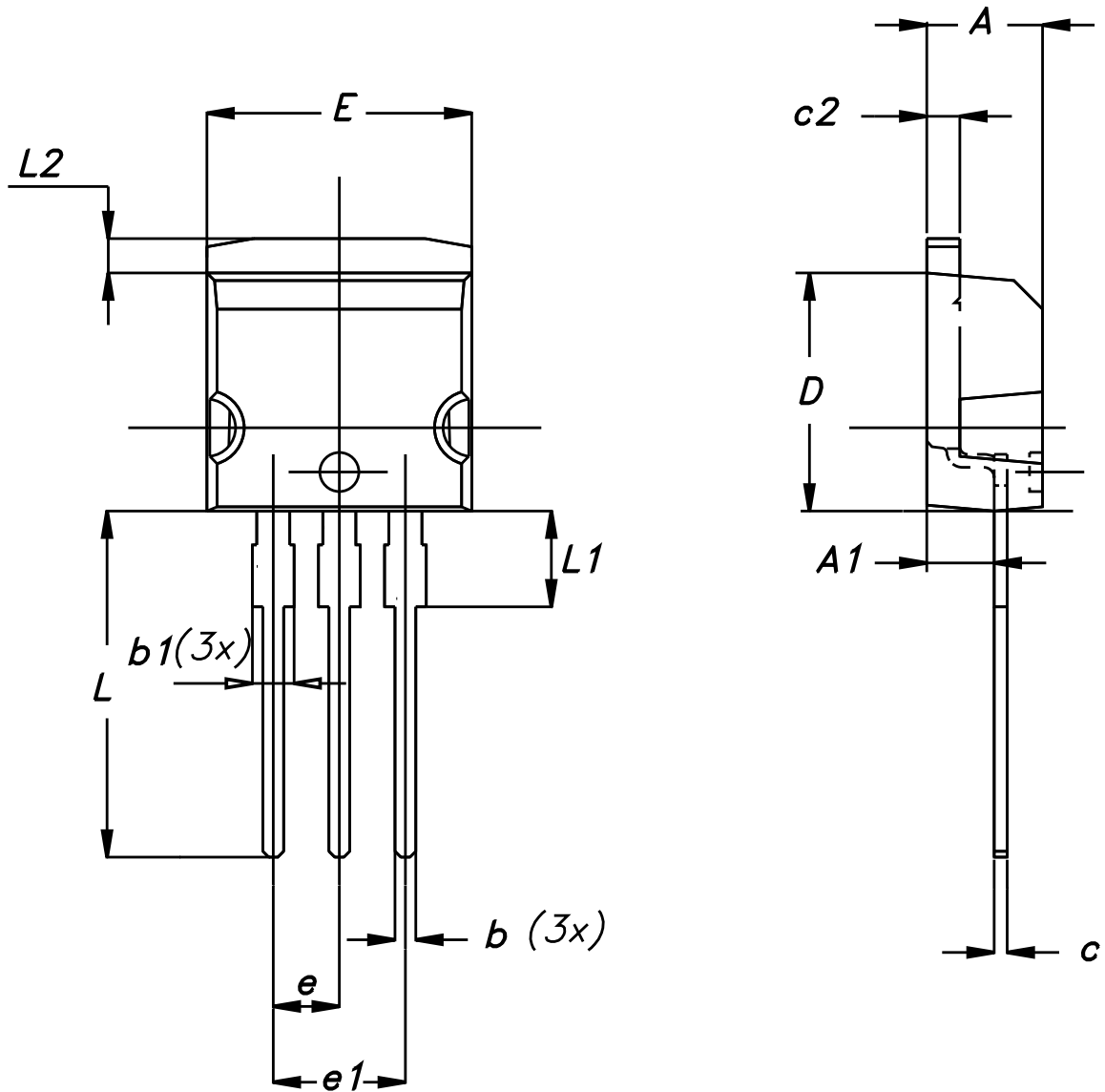
7012510\_Rev\_13\_B

**Table 8. TO-220FP package mechanical data**

Dim.	mm		
	Min.	Typ.	Max.
A	4.40		4.60
B	2.50		2.70
D	2.50		2.75
E	0.45		0.70
F	0.75		1.00
F1	1.15		1.70
F2	1.15		1.70
G	4.95		5.20
G1	2.40		2.70
H	10.00		10.40
L2		16.00	
L3	28.60		30.60
L4	9.80		10.60
L5	2.90		3.60
L6	15.90		16.40
L7	9.00		9.30
Dia	3.00		3.20

## 4.2 I<sup>2</sup>PAK package information

Figure 25. I<sup>2</sup>PAK package outline



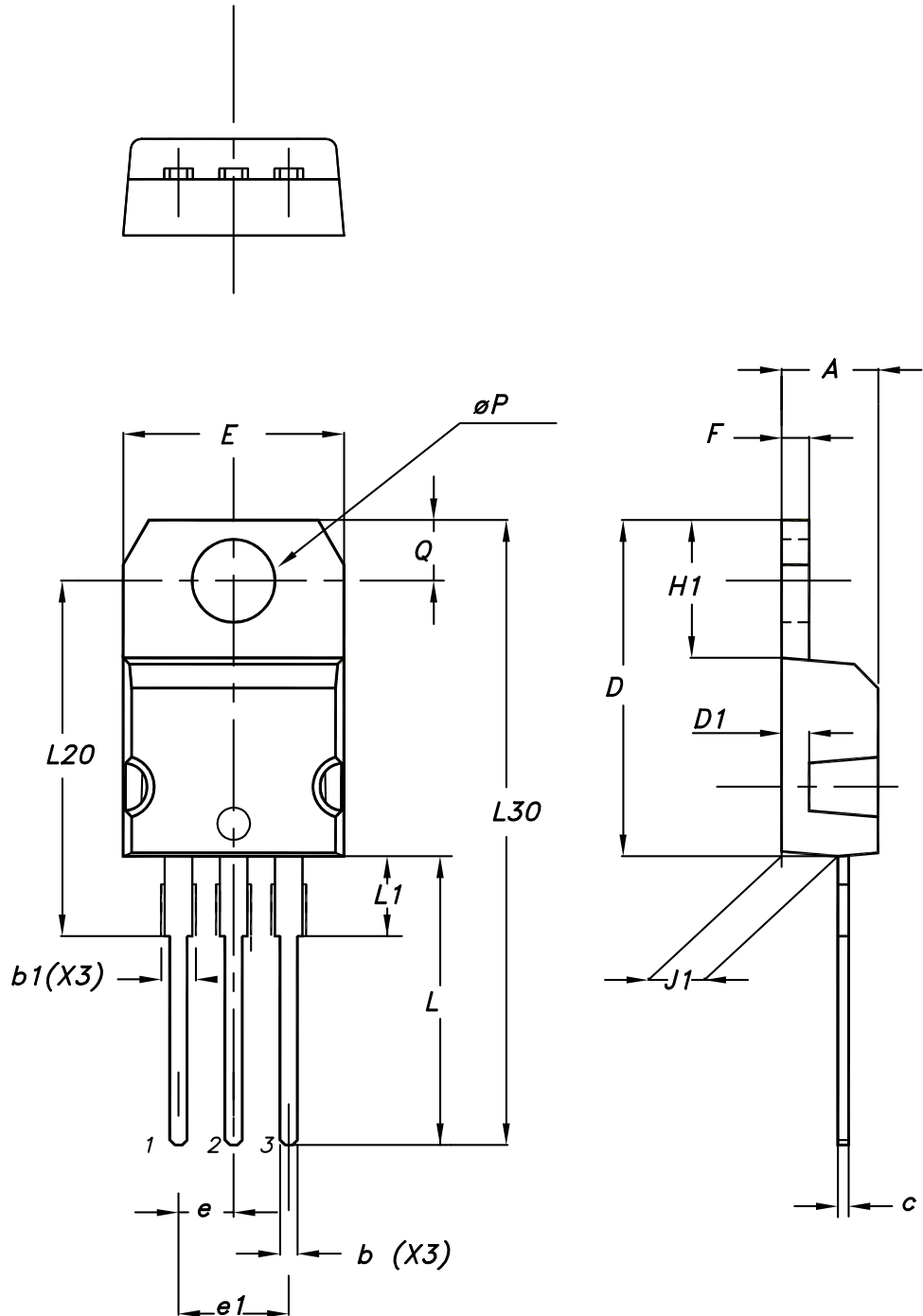
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**Table 9. I<sup>2</sup>PAK package mechanical data**

Dim.	mm		
	Min.	Typ.	Max.
A	4.40	-	4.60
A1	2.40	-	2.72
b	0.61	-	0.88
b1	1.14	-	1.70
c	0.49	-	0.70
c2	1.23	-	1.32
D	8.95	-	9.35
e	2.40	-	2.70
e1	4.95	-	5.15
E	10	-	10.40
L	13	-	14
L1	3.50	-	3.93
L2	1.27	-	1.40

### 4.3 TO-220 type A package information

Figure 26. TO-220 type A package outline



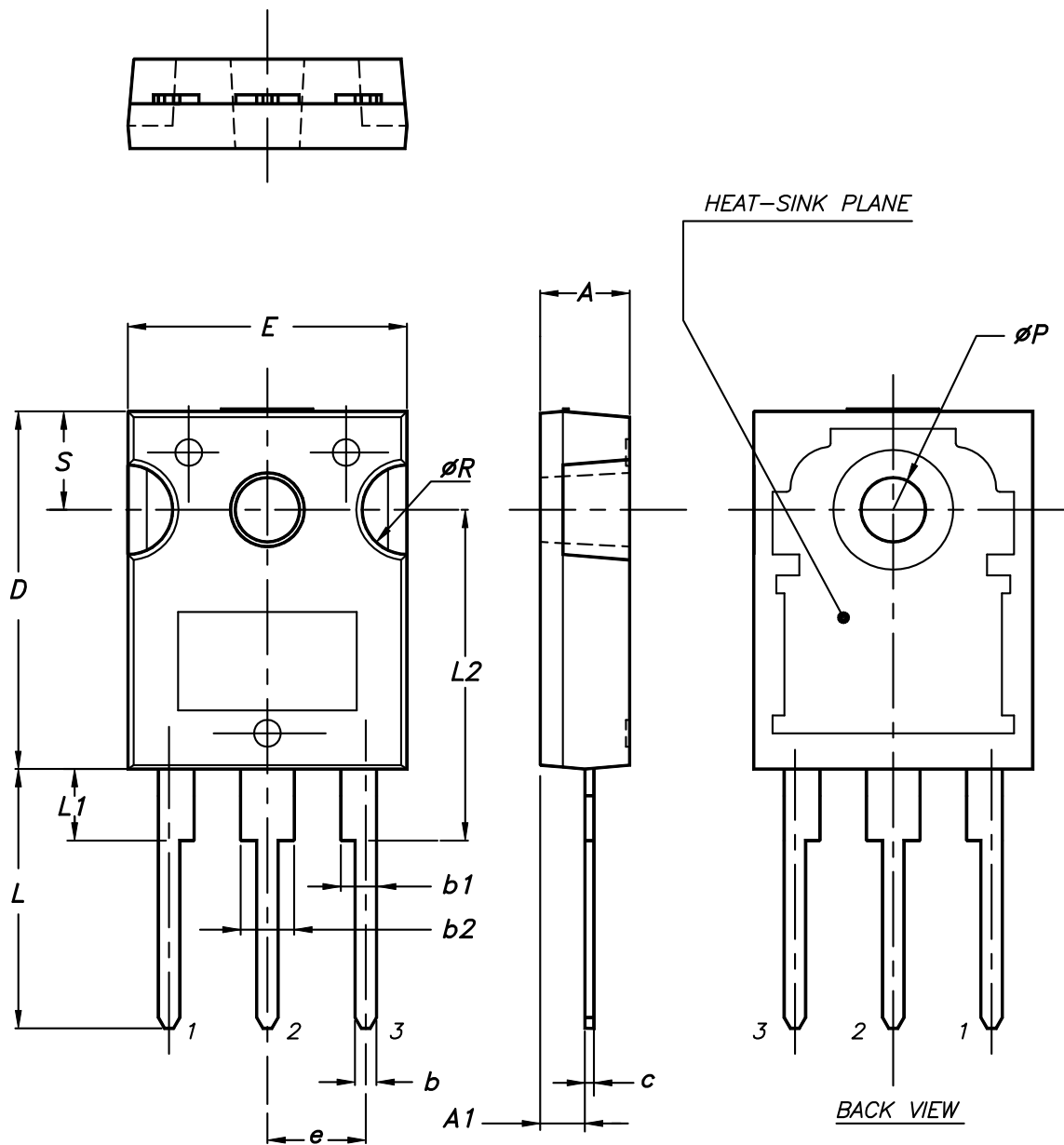
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**Table 10. TO-220 type A package mechanical data**

Dim.	mm		
	Min.	Typ.	Max.
A	4.40		4.60
b	0.61		0.88
b1	1.14		1.55
c	0.48		0.70
D	15.25		15.75
D1		1.27	
E	10.00		10.40
e	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13.00		14.00
L1	3.50		3.93
L20		16.40	
L30		28.90	
øP	3.75		3.85
Q	2.65		2.95

#### 4.4 TO-247 package information

Figure 27. TO-247 package outline



0075325\_9

**Table 11. TO-247 package mechanical data**

Dim.	mm		
	Min.	Typ.	Max.
A	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
c	0.40		0.80
D	19.85		20.15
E	15.45		15.75
e	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S	5.30	5.50	5.70



## 5 Ordering information

**Table 12. Order codes**

Order code	Marking	Package	Packing
STF33N60M2	33N60M2	TO-220FP	Tube
STI33N60M2		I <sup>2</sup> PAK	
STP33N60M2		TO-220	
STW33N60M2		TO-247	

## Revision history

**Table 13. Document revision history**

Date	Version	Changes
13-Sep-2013	1	First release.
19-Nov-2013	2	<p>Modified: <math>R_{DS(on)}</math> and <math>I_D</math> values in cover page</p> <p>Modified: values in <i>Table 4</i></p> <p>Modified: <math>R_{DS(on)}</math> typical and maximum values in <i>Table 5</i>, the entire typical values in <i>Table 6, 7 and 8</i></p> <p>Added: <i>Section 2.1: Electrical characteristics (curves)</i></p> <p>Minor text changes</p>
14-Jun-2019	3	<p>Removed maturity status indication from cover page.</p> <p>Updated title, features and description.</p> <p>Updated <a href="#">Table 3. Avalanche characteristics</a>.</p> <p>Added <a href="#">Figure 17. Maximum avalanche energy vs temperature</a>.</p> <p>Minor text changes</p>

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